USB Type-C® Connectors

Essential Knowledge Guide #1









Over 30 years of innovation in connectivity

As a member of the Aloco Group, GCT is an established manufacturer of world class connector and cable assembly solutions.

Companies the world over trust our extensive range of solutions to enable connectivity within their designs. Our drive for product innovation has helped our customers stay at the forefront of their industries.

www.gct.co



Universal Serial Bus

Designed as a universal connection for computer peripherals back in the 1990s, the Universal Serial Bus (USB) promised a user friendly, hot pluggable, self-configuring standard to replace a growing list of proprietary solutions.

In the intervening years, however, there have been more than a dozen different plug configurations - to accommodate varying power and data requirements - so it could be argued that the 'universal' element of the name hasn't exactly held true.

The good news is that the latest version has been designed to satisfy the vast majority of user needs in a single, plug/socket configuration – the USB Type-C.

The aim of this guide is to help provide the essential knowledge that can help you select a USB Type-C that is best suited to your application in Not only is it faster and more powerful, terms functionality and, just as it is also fully reversible so it can't be importantly, price point. plugged in the wrong way, like previous versions. Without doubt this makes it much more user-friendly and better for users but, in its fully-featured 24 pin versions, it can be over engineered for many applications.



USB Type-C® Evolution

First proposed in 2013, USB Type-C[®] was developed to be compact, reversible and deliver significant increases in data speed and power delivery.

The original specification delivered speeds of 5Gbps with the Gen2 rated at 10Gbps. The latest version for fully specified USB Type-C at 10Mbps is USB3.2

Gen2 delivering performance that allows download of a 4K move in around 16 seconds compared to over 5 minutes via USB2.0.



USB3.2 Gen 1		
Power (max.)	100W	
Current (max.)	5A	
Voltage (max.)	20V	
Data speed (max.)	5Gbps	



LICDA A COR A

03B3.2 Gen 2		
Power (max.)	100W	
Current (max.)	5A	
Voltage (max.)	20V	
Data speed (max.)	10Gbps	



0000.2	
Power (max.)	100W
Current (max.)	5A
Voltage (max.)	20V
Data speed (max.)	20Gbps

USB3 2 Gen 2x2

Do you need all that speed and all that power?

If you do, then USB Type-C[®] in 24-pin format is ideal for you, and GCT has many options for you to choose from. If you don't, then there are further options you should consider.

GCT has developed two ranges of connectors with reduced functionality for applications that require USB2.0

specification (16 pin) or I/O charging only (6 pin) while still offering the benefits of the USB Type-C® format.

Theses ranges have been developed specifically to reduce the unit price for customers who want the features of USB Type-C® but don't need - and don't wnat to pay for - all the features.



USB4

Power (max.)

Current (max.)

Voltage (max.

Data speed (r



240W		I
5A		(
48V		١
20Gbps		
	5A 48V	5A 48V

USB4	
Power (max.)	240W
Current (max.)	5A
Voltage (max.)	48V
Data speed (max.)	40Gbps

2013 2017

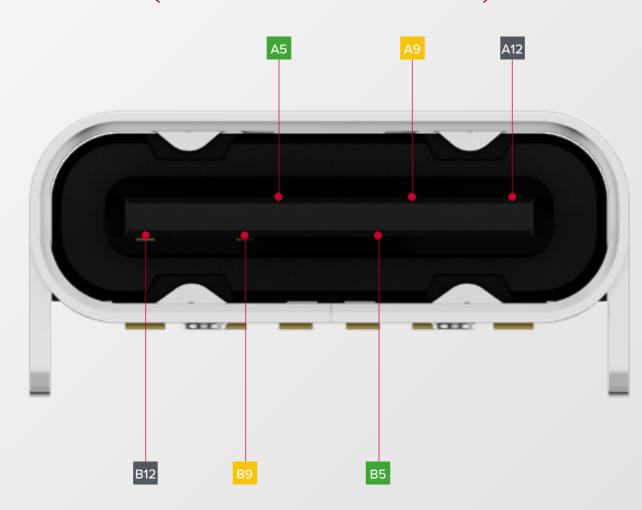






Rated at up to 60W (3A @ 20V max)

Pin	Signal	Mating Sequence		
-	-	-		
-	-	-		
-	-	-		
-	-	-		
A5	CC1	Second		
-	-	-		
-	-	-		
-	-	-		
A9	VBUS	First		
-	-	-		
-	-	- /		
A12	GND	First		
SHELL	GROUND			





Pin	Signal	Mating Sequence
B12	GND	First
-	-	-
-	-	-
В9	VBUS	First
-	-	-
-	-	-
-	-	-
B5	CC2	Second
-	-	
-	-	-
	-	-
-	-	-
SHELL	GROUND	

Ground
Configuration channels
Bus Power

Reversible and fully compatible with all USB Type-C cable assemblies

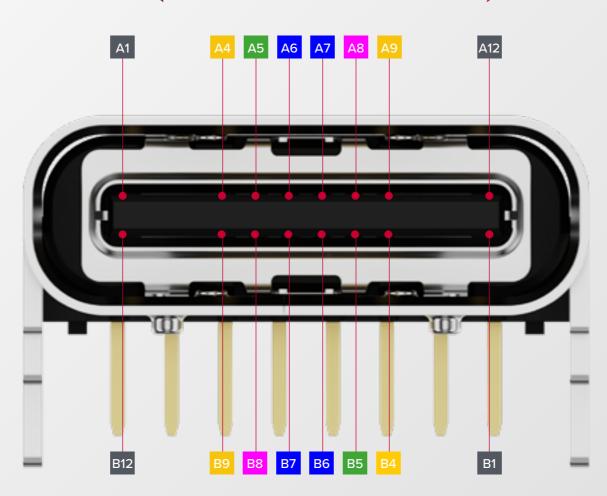






Rated at up to 100W (5A @ 20V max)

Pin	Signal	Mating Sequence
A1	GND	First
-	-	-
-	-	-
A4	VBUS	First
A5	CC1	Second
A6	Dp1	Second
A7	Dn1	Second
A8	SBU1	Second
A9	VBUS	First
-	-	-
-	-	-
A12	GND	First
SHELL	GROUND	



Reversible and fully compatible with all USB Type-C cable assemblies

16pin

Pin	Signal	Mating Sequence
B12	GND	First
-	-	-
-	7-	-
В9	VBUS	First
B8	SBU2	Second
B7	Dn2	Second
B6	Dp2	Second
B5	CC2	Second
B4	VBUS	First
-	-	-
-	-	-
B1	GND	First
SHELL	GROUND	

Ground

Configuration channels

Sideband Use

USB 2.0 differential pairs

Bus Power



power and data+

Series developed for applications requiring USB3.2 Gen2.

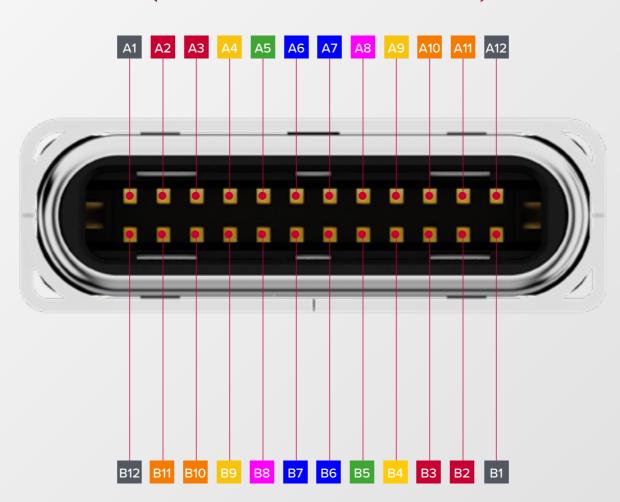
Ideal connector for applications requiring very high data and power rates.





Rated at up to 100W (5A @ 20V max)

Pin	Signal Mating Sequence	
A1	GND	First
A2	TXp1	Second
A3	TXn1	Second
Α4	VBUS	First
A5	CC1	Second
A6	Dp1	Second
A7	Dn1	Second
A8	SBU1	Second
A9	VBUS	First
A10	RXn2	Second
A11	RXp2	Second
A12	GND	First
SHELL	GROUND	



Reversible and fully compatible with all USB Type-C cable assemblies

24pin

Pin	Signal	Mating Sequence
B12	GND	First
B11	RXp1	Second
B10	RXn1	Second
B9	VBUS	First
B8	SBU2	Second
B7	Dn2	Second
B6	Dp2	Second
B5	CC2	Second
B4	VBUS	First
В3	TXn2	Second
B2	TXp2	Second
B1	GND	First
SHELL	GROUND	

Ground

High speed data path 1

Configuration channels

Sideband Use

USB 2.0 differential pairs

Bus Power

High speed data path 2



Orientation, gender and PCB position

PCB Mount Position

Mid mount

This is where the connector sits in a cut out in the PCB. The advantage of this mounting style is a reduced profile.

Top mount

This is where the component sits on the surface of the PCB.

Edge mount

This is where the connector is fitted to the edge of the PCB. Edge mound connectors are often also mid mount.

Orientation

♦ Vertical

Part is placed on the PCB at a 90° angle.

Part is placed in the same plane as the PCB.

Gender

Plug/Male

Usually part of a cable assembly, however plugs can also be PCB mounted in applications such a docking stations.

Socket/Receptacle/Female





Mid-mount offset

The offset is the measurement from the underside of the mid-mount connector shell to the top side of the PCB. This allows the connector to be positioned in a suitable alignment for the application.



Illustration shows the offset based on the USB4520

USB4500

USB4505

USB4515

USB4510

USB4520











0.80mm OFFSET



1.60mm OFFSET

1.60mm OFFSET

2.10mm OFFSET







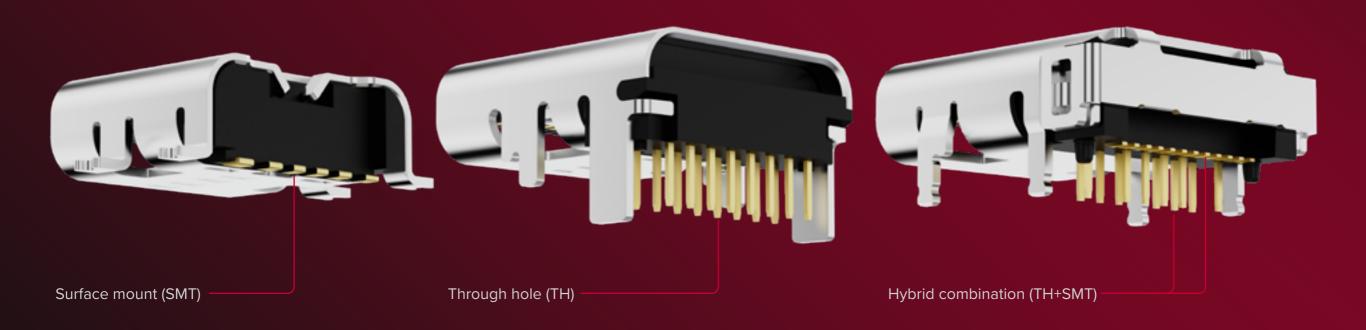






Contact pin type

Parts are available with either through hole (TH), surface mount (SMT) or hybrid combination (TH+SMT).



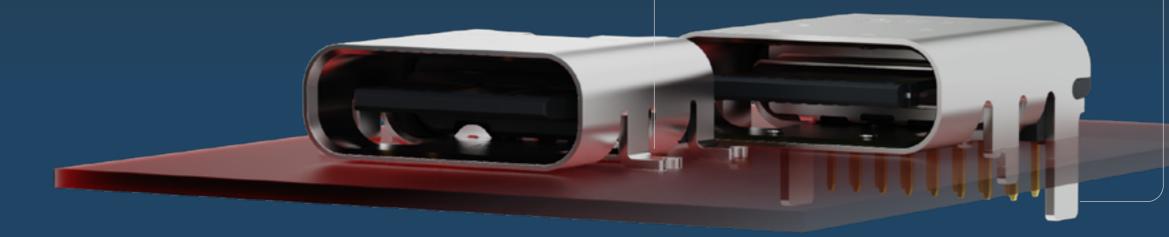


Shell stake types

A shell stake is a part of the metal shell that is used to make a robust fixing to the PCB. The contact pins are relatively small, so shell stakes add additional strength and stability after soldering. Shell stakes can be either through hole (TH) or surface mount (SMT).

Surface mount (SMT)

Through hole (TH)



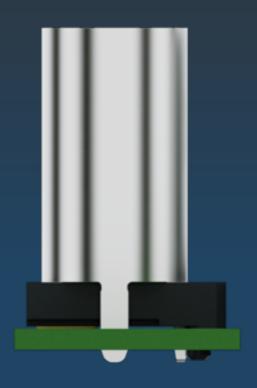
Note - Parts with TH solder stakes can be soldered using IR reflow process if Pin in Paste technology is used (see solder process)

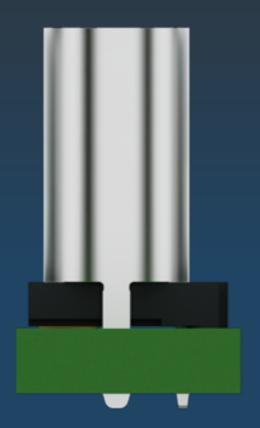


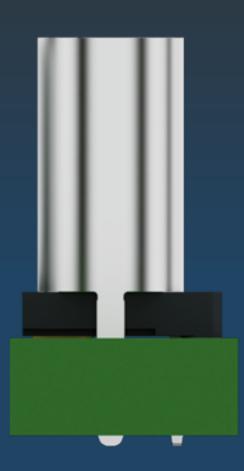
Shell stake lengths

Shell stakes are designed to add strength to the PCB

fixing. As PCB thickness is not universal, through hole (TH) shell stakes come in a variety of lengths. Through hole shell stakes are suitable for reflow solder processes, so pin in paste technology can be used if needed.







In this example we have the USB4140 at different shell stakes, 0.70mm, 1.70mm and 2.30mm

0.60mm PCB with a 0.70mm shell stake length

1.60mm PCB with a 1.70mm shell stake length

2.00mm PCB with a2.30mm shell stake length



Hand soldering – Using a good old fashioned soldering iron and solder.

Wave soldering – The circuit board is passed over a pan of molten solder in which a pump produces an upwelling of solder that looks like a standing wave. As the circuit board makes contact with this wave, the components become soldered to the board.

https://en.wikipedia.org/wiki/Wave_soldering

IR reflow soldering – This is a process in which a solder paste (a sticky mixture of powdered solder and flux) is used to temporarily attach electrical components to their contact pads after which the entire assembly is subjected to controlled heat. The solder paste reflows in a molten state, creating permanent solder joints. Heating may be accomplished by passing the assembly through a reflow oven or under an infrared lamp.

https://en.wikipedia.org/wiki/Reflow_soldering

Note - Parts with SMT contacts pins and TH solder stakes can be soldered using IR reflow process if Pin in Paste technology is used.

In the Pin-in-Paste (PIP) process, the solder paste is screen printed into the through holes. After solder application, the component is placed in the holes. The board then undergoes reflow soldering in order to form the solder joint.



Shell Plating This refers to the coating of metal

that is applied to the connector metal shell. This is usually nickel with $30 - 50\mu$ " thickness.

Contact plating

This refers to the coating of metal that is applied to the internal contact pins. This is always gold and can range between gold flash (GF) and 30μ " thickness. GF is usually between 1 and 3μ " thick.

Solder tail plating

This refers to the coating of metal that is applied to the PCB solder pins. This is typically tin or gold and can range between gold flash (GF) up to 30μ " thickness. GF is usually between 1 and 3μ " thick.



Body length

Body length refers to the total length from the mating face to the rear plate. It does not include the length of the PCB contacts

Profile

Profile refers to the height of the connector above the PCB. Horizontal connectors have a lower profile than vertical types



Shell springs

Unlike earlier USB versions, USB Type-C usually does not have shell springs on either the plug or receptacle.

Retention Latches

For USB Type-C the mating and unmating strength is controlled via side latches in the plug connector (the one that is most commonly on a cable).

Mating cycles

Mating cycles refers to the number of times a connector can be used while still meeting the minimum force specified. All USB Type-C connectors meet 10,000 cycle and some GCT 6 pin parts are rated at 20,000 cycles.





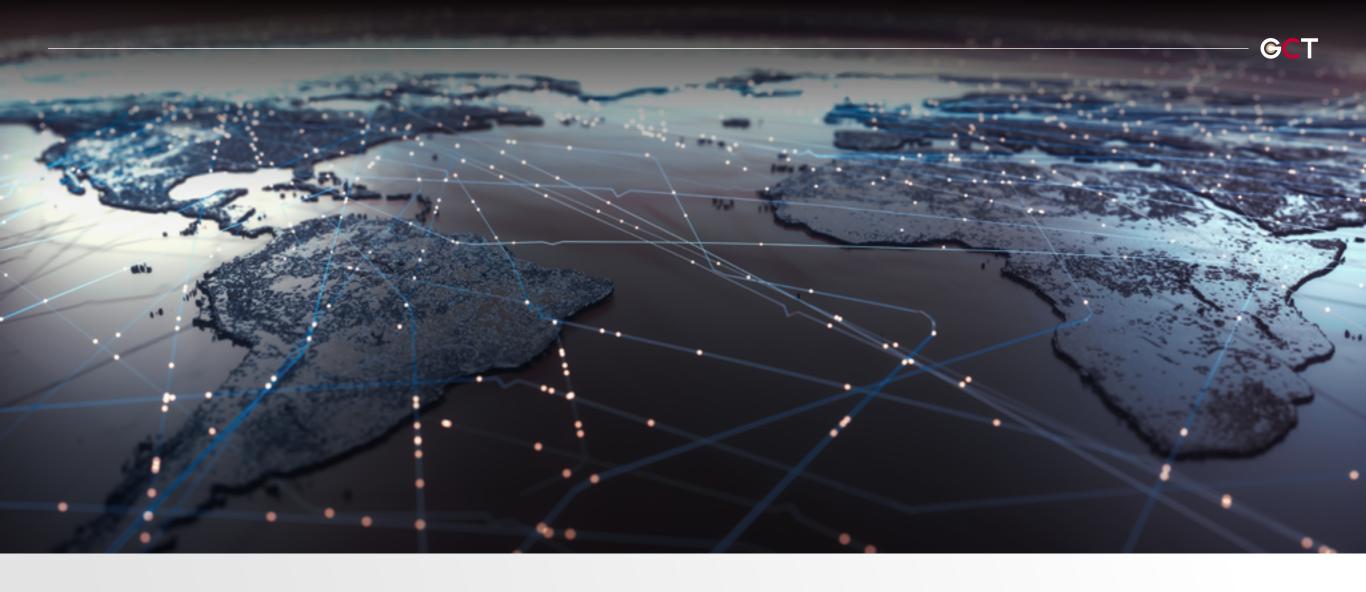
6pin	USB4125	USB4130	USB4135	USB4140	USB4515
USB Version	Power Only				
Gender	Receptacle	Receptacle	Receptacle	Receptacle	Receptacle
Number of contacts	6	6	6	6	6
PCB Orientation	Horizontal	Vertical	Horizontal	Vertical	Horizontal
PCB Mount Position	Тор	Тор	Тор	Тор	Mid
Shell Stake Type	Thru-hole	Thru-hole	SMT	Thru-hole	Thru-hole
Profile Height	3.16mm	6.50mm	3.16mm	6.50mm	3.16mm
Body Length	6.80mm	6.50mm	6.90mm	6.50mm	6.80mm
PCB Pin Type	SMT	SMT	SMT	SMT	SMT
Mid Mount offset	-	-	-	-	1.60mm
Shell Stake Length 1	1.00mm	1.20mm	-	0.70mm	0.75mm
Shell Stake Length 2	1.90mm	-	-	1.70mm	-
Shell Stake Length 3	-	-	-	2.30mm	-
Contact Plating	Gold Flash				
Current Rating	3A	3A	3A	ЗА	3A
Mating Cycles	20000	10000	20000	10000	10000



16pir	USB4085	USB4105	USB4110	USB4120	USB4145	USB4500	USB4505	USB4510	USB4520
USB Version	2.0	2.0	2.0	2.0	2.0	2.0	2.0	2.0	2.0
Gender	Receptacle								
Number of contacts	16	16	16	16	16	16	16	16	16
PCB Orientation	Horizontal	Horizontal	Horizontal	Vertical	Vertical	Horizontal	Horizontal	Horizontal	Horizontal
PCB Mount Position	Тор	Тор	Тор	Тор	Тор	Mid	Mid	Mid	Mid
Shell Stake Type	Thru-hole	Thru-hole	SMT	Thru-hole	Thru-hole	Thru-hole	Thru-hole	Thru-hole	Thru-hole
Profile Height	3.46mm	3.31mm	3.26mm	6.50mm	7.46mm	3.16mm	3.16mm	3.16mm	3.16mm
Body Length	9.17mm	7.53mm	7.35mm	6.50mm	5.90mm	6.50mm	6.50mm	6.50mm	6.50mm
PCB Pin Type	Thru-hole	SMT							
Mid Mount offset	-	-	-	-	-	0.80mm	1.00mm	1.60mm	2.10mm
Shell Stake Length 1	2.10mm	0.60mm	-	0.95mm	0.70mm	0.70mm	0.80mm	0.70mm	0.85mm
Shell Stake Length 2	-	0.95mm	-	-	1.70mm	-	-	-	-
Shell Stake Length 3	-	1.20mm	-	-	2.30mm	-	-	-	-
Contact Plating	Gold Flash	Gold Flash	Gold Flash	3μ" gold					
Current Rating	5A								
Mating Cycles	10000	10000	10000	10000	10000	10000	10000	10000	10000



24nin			SA		Sp.						
	USB4050	USB4055	USB4056	USB4060	USB4065	USB4070	USB4080	USB4115	USB4151	USB4155	USB4160
USB Version	3.2 GEN2	3.2GEN2									
Gender	Receptacle	Plug	Plug	Receptacle							
Number of contacts	24	24	24	24	24	24	24	24	24	24	24
PCB Orientation	Horizontal	Horizontal	Horizontal	Horizontal	Horizontal	Vertical	Horizontal	Vertical	Vertical	Horizontal	Vertical
PCB Mount Position	Mid	Тор	Тор	Mid	Тор	Тор	Тор	Тор	Тор	Edge	Тор
Shell Stake Type	Thru-hole										
Profile Height	3.42mm	3.46mm	3.31mm	3.42mm	3.46mm	10.50mm	3.16mm	9.25mm	11.10mm	2.90mm	7.46mm
Body Length	10.0mm	10.0mm	9.87mm	8.65mm	8.65mm	10.50mm	7.90mm	9.25mm	11.10mm	15.50mm	5.90
PCB Pin Type	Hybrid	Hybrid	Hybrid	Hybrid	Hybrid	SMT	SMT	SMT	SMT	SMT	SMT
Mid Mount offset	1.37mm	-	-	1.37mm	-	-	-	-	-	-	-
Shell Stake Length 1	0.60mm	1.20mm	1.15mm	0.60mm	1.20mm	1.30mm	0.50mm	1.15mm	1.25mm	0.90mm	0.70mm
Shell Stake Length 2	-	-	1.40mm	-	-	-	-	-	-	-	1.70mm
Shell Stake Length 3	-	-	-	-	-	-	-	-	-	-	2.30mm
Contact Plating	30μ" gold	30μ" gold	3μ" gold	30μ" gold	3μ" gold	30μ" gold	3μ" gold	3μ" gold	Gold Flash	3μ" gold	3μ" gold
Current Rating	5A										
Mating Cycles	10000	10000	10000	10000	10000	10000	10000	10000	10000	10000	10000



Globally Connected

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